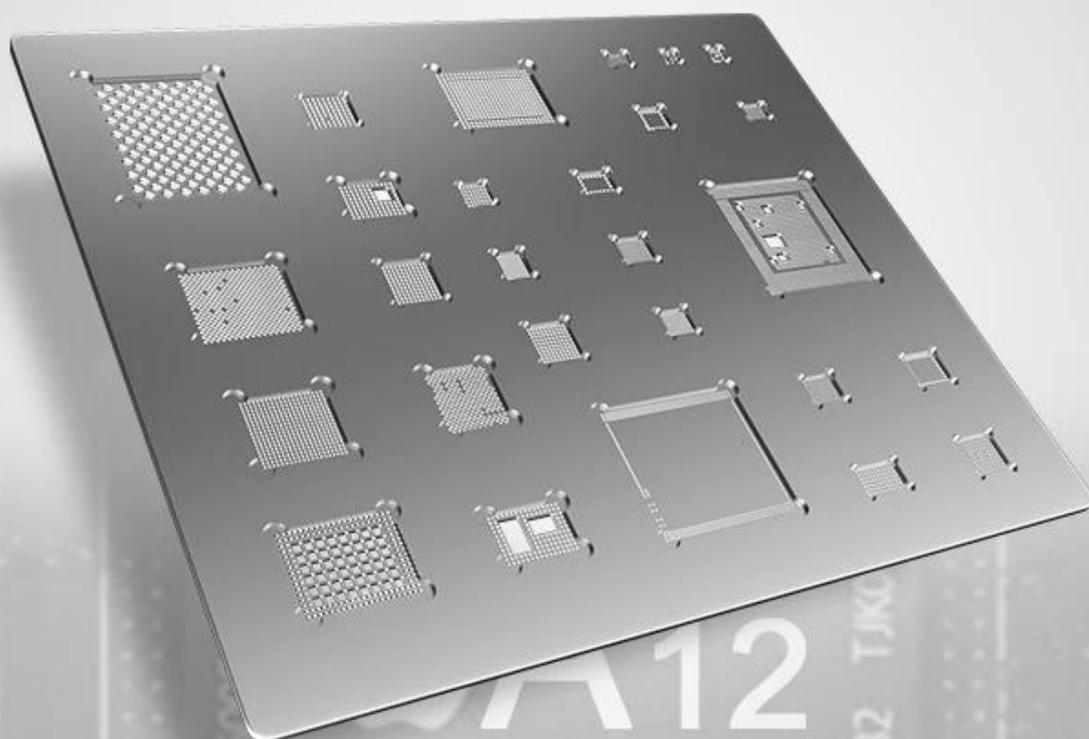


Description du produit

Ce produit est utilisé pour la réparation par étamage BGA de la série Iphone XS / XS MAX / XR.
Acier importé, anti-roulement, anti-déformation, alignement automatique, position du trou précise, étain antiadhésif, bonne ténacité, bon hors réseau.

3D GROOVE — REBALLING STENCIL —



SEMI-ETCHING PROCESS



COOLING HOLE DESIGN

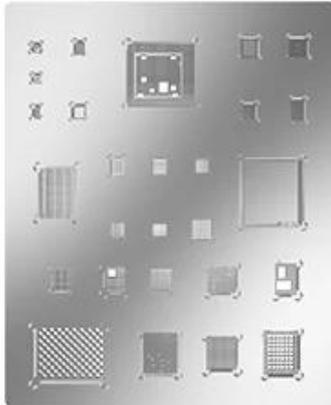


PRECISE ALIGNMENT



SQUARE HOLE

Product Usage



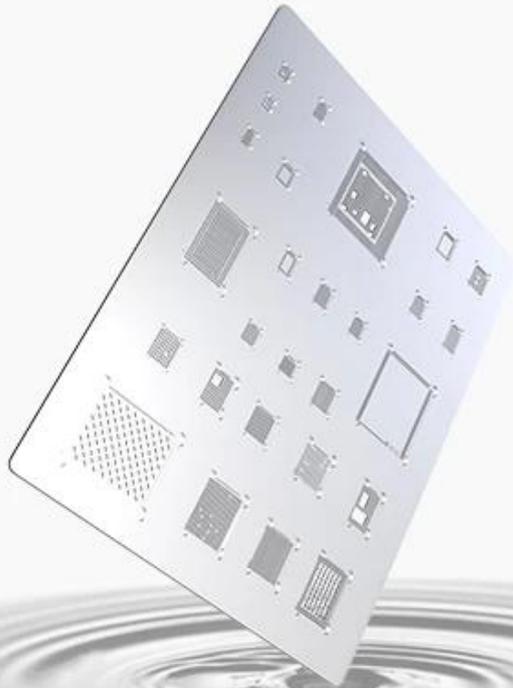
MODEL	A12
WEIGHT	18.6g
MATERIAL	imported steel
SIZE	68.9 X 84.9mm
MATCHING MACHINE TYPE	iPhone XS/XS Max/XR

▼ CHARACTERISTICS

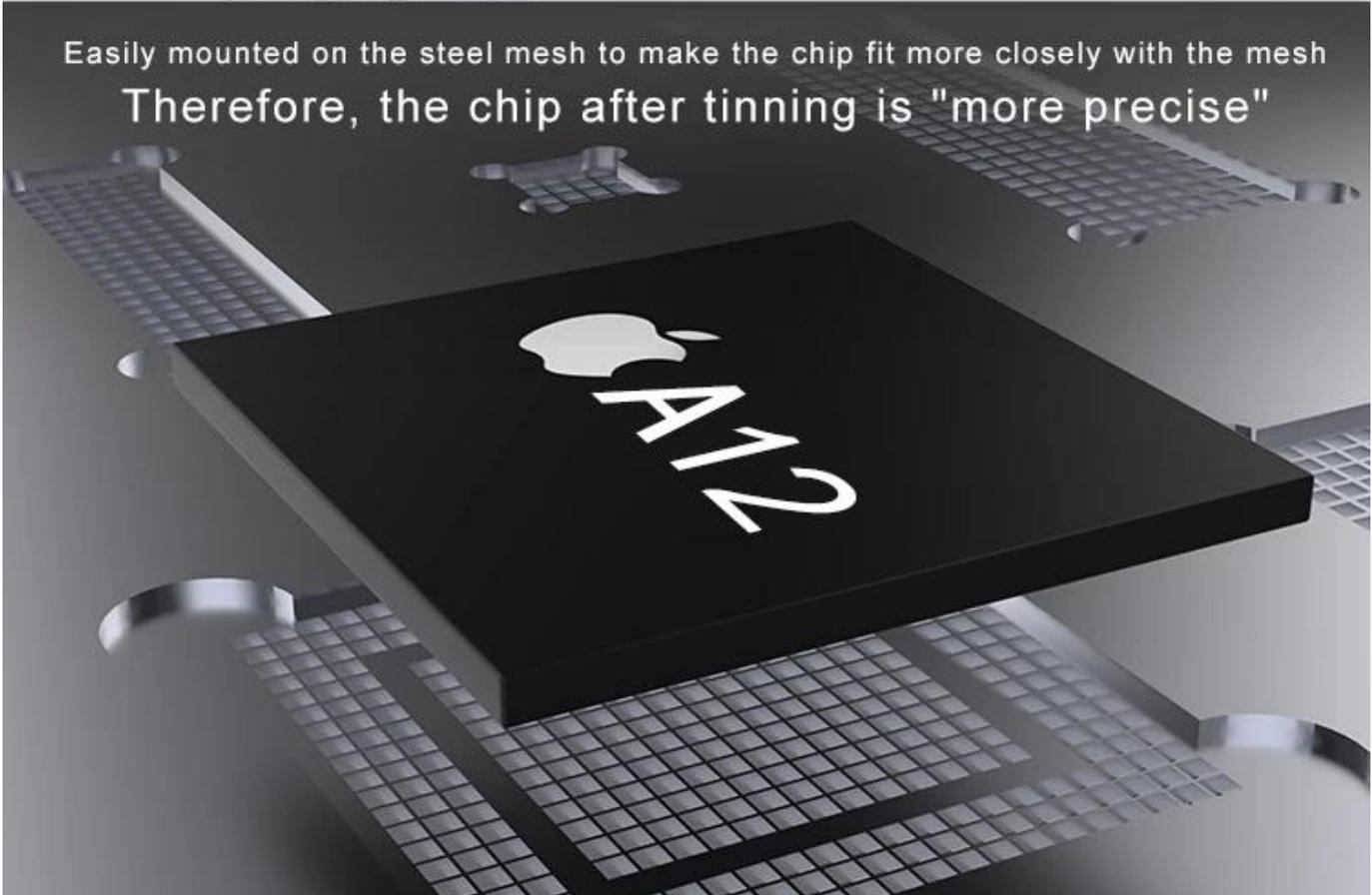
This product is used for BGA tinning repair of the iPhone XS/XS Max/XR series. Imported steel, anti-rolling anti-deformation, automatic alignment, accurate hole position, non-stick tin, good toughness, good off-grid.

IMPORTED STEEL

HIGH TOUGHNESS



Easily mounted on the steel mesh to make the chip fit more closely with the mesh
Therefore, the chip after tinning is "more precise"

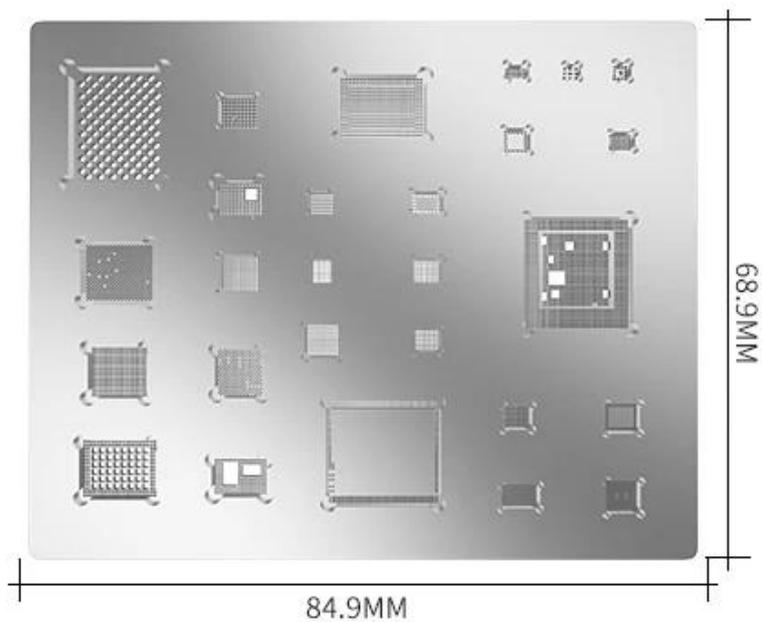


A11Z

A 3D rendering of an Apple A11Z chip mounted on a steel mesh board. The chip is black with the Apple logo and the text "A11Z" in white. The mesh board is silver and has a grid pattern. The chip is shown in a perspective view, highlighting its fit on the mesh.



PRODUCT SIZE



Thin to 0.33mm

Precise die-casting **form heating**



